

**4N60K-TA**

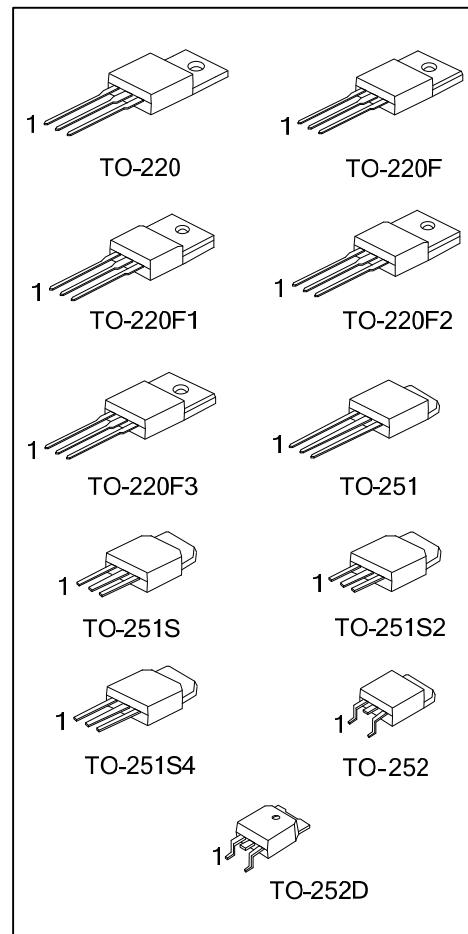
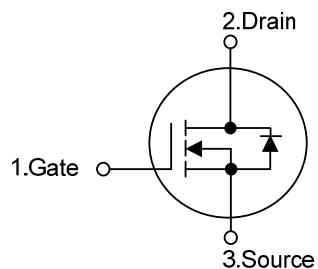
Preliminary

**Power MOSFET****4A, 600V N-CHANNEL  
POWER MOSFET****■ DESCRIPTION**

The UTC **4N60K-TA** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

**■ FEATURES**

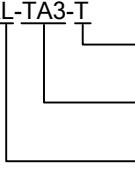
- \*  $R_{DS(ON)} < 2.8\Omega$  @  $V_{GS}=10$  V,  $I_D=2.0$ A
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, high Ruggedness

**■ SYMBOL**

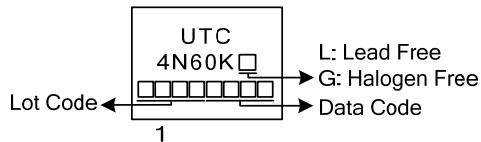
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4N60KL-TA3-T	4N60KG-TA3-T	TO-220	G	D	S	Tube
4N60KL-TF3-T	4N60KG-TF3-T	TO-220F	G	D	S	Tube
4N60KL-TF1-T	4N60KG-TF1-T	TO-220F1	G	D	S	Tube
4N60KL-TF2-T	4N60KG-TF2-T	TO-220F2	G	D	S	Tube
4N60KL-TF3T-T	4N60KG-TF3T-T	TO-220F3	G	D	S	Tube
4N60KL-TM3-T	4N60KG-TM3-T	TO-251	G	D	S	Tube
4N60KL-TMS-T	4N60KG-TMS-T	TO-251S	G	D	S	Tube
4N60KL-TMS2-T	4N60KG-TMS2-T	TO-251S2	G	D	S	Tube
4N60KL-TMS4-T	4N60KG-TMS4-T	TO-251S4	G	D	S	Tube
4N60KL-TN3-R	4N60KG-TN3-R	TO-252	G	D	S	Tape Reel
4N60KL-TND-R	4N60KG-TND-R	TO-252D	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 4N60KL-TA3-T	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251 TMS: TO-251S, TN3: TO-252, TND: TO-252D (3) L: Lead Free, G: Halogen Free and Lead Free
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### ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	600	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Avalanche Current (Note 2)		$I_{AR}$	4.0	A
Drain Current	Continuous	$I_D$	4.0	A
	Pulsed (Note 2)	$I_{DM}$	16	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	160	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.8	V/ns
Power Dissipation	TO-220	$P_D$	106	W
	TO-220F/TO-220F1		36	W
	TO-220F2/TO-220F3		50	W
	TO-251/TO-251S	$P_D$	0.848	W/°C
	TO-251S2/TO-251S4		0.288	W/°C
Derate above 25°C	TO-252/TO-252D		0.4	W/°C
Junction Temperature		$T_J$	+150	°C
Operating Temperature		$T_{OPR}$	-55 ~ +150	°C
Storage Temperature		$T_{STG}$	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3.  $L = 20\text{mH}$ ,  $I_{AS} = 4.0\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 4.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

## ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	°C/W
	TO-220F1/TO-220F2			
Junction to Case	TO-220F3		83	°C/W
	TO-251/TO-251S	$\theta_{JC}$		
Junction to Case	TO-251S2/TO-251S4	1.18	°C/W	
	TO-252/TO-252D			
	TO-220	3.47	°C/W	
	TO-220F/TO-220F1			
	TO-220F3	3.4	°C/W	
	TO-220F2			
	TO-251/TO-251S	2.5	°C/W	
	TO-251S2/TO-251S4			
	TO-252/TO-252D			

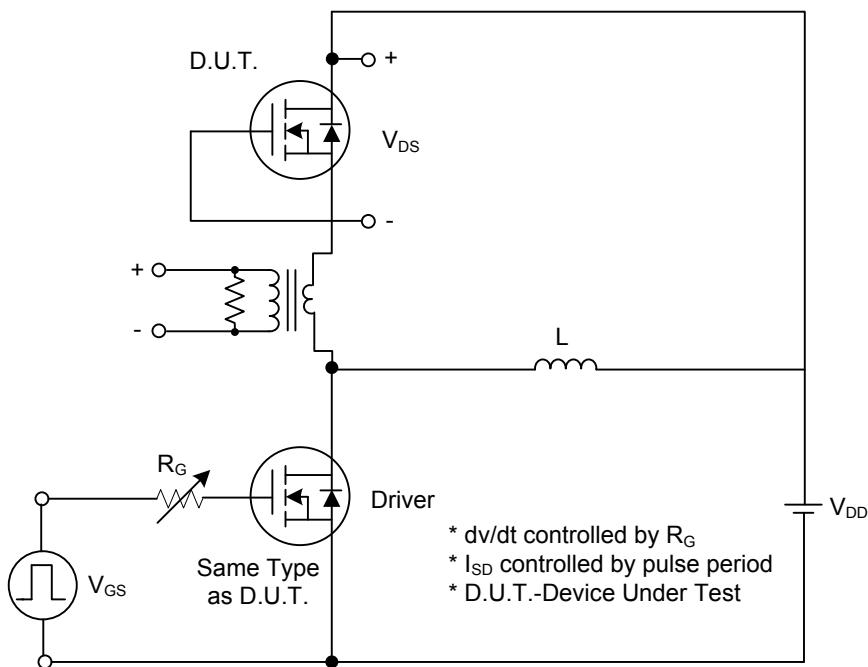
■ ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$		10		$\mu\text{A}$
		$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}, T_C=125^\circ\text{C}$		10		$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$		100		nA
		$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$		-100		nA
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$ , Referenced to $25^\circ\text{C}$		0.6		$\text{V}^\circ\text{C}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2.0\text{A}$			2.8	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		268		pF
Output Capacitance	$C_{\text{OSS}}$			49		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			5.3		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$Q_G$	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=13\text{A}$ $I_G = 100\mu\text{A}$ (Note1, 2)		38		nC
Gate-Source Charge	$Q_{\text{GS}}$			4.4		nC
Gate-Drain Charge	$Q_{\text{GD}}$			4.6		nC
Turn-On Delay Time	$t_{\text{D(ON)}}$	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=0.5\text{A}, R_G=25\Omega$ (Note1, 2)		50		ns
Turn-On Rise Time	$t_R$			30		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			136		ns
Turn-Off Fall Time	$t_F$			30		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				4.0	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				16	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 4.0\text{A}$			1.4	V
Reverse Recovery Time	$t_{\text{rr}}$	$V_{\text{GS}} = 0\text{V}, I_S = 4.0\text{A}, dI_F / dt = 100\text{A}/\mu\text{s}$ (Note 1)		290		nS
Reverse Recovery Charge	$Q_{\text{RR}}$			0.23		$\mu\text{C}$

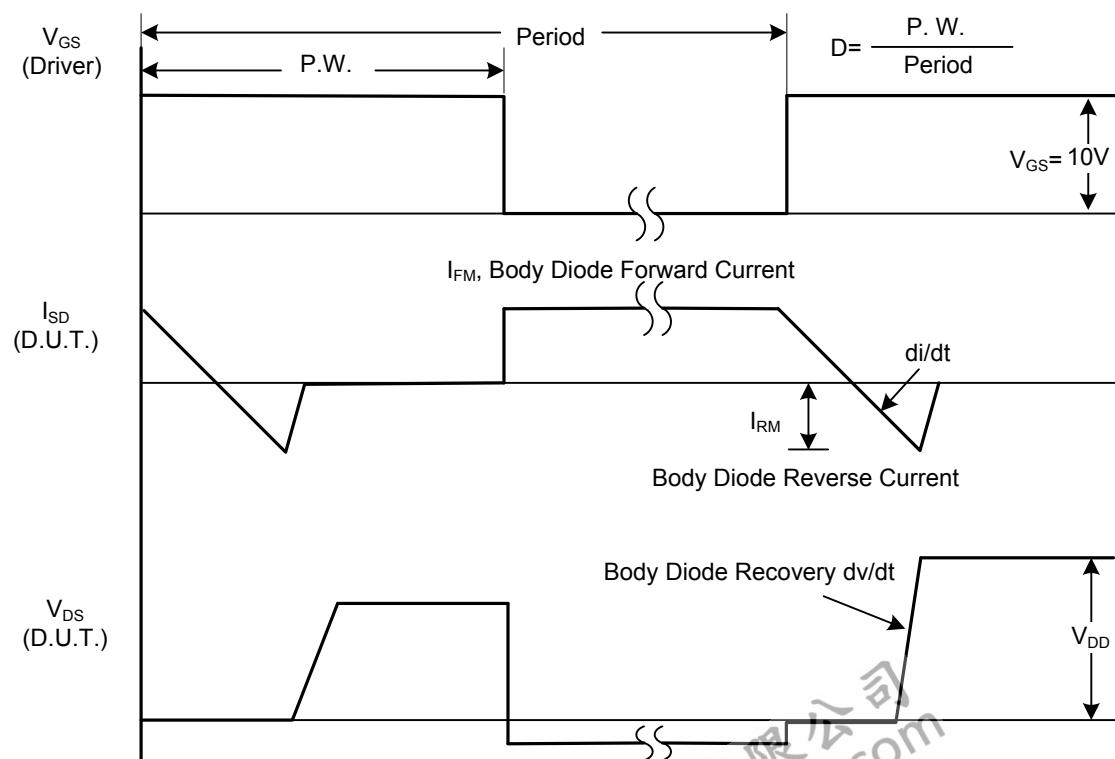
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ 

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

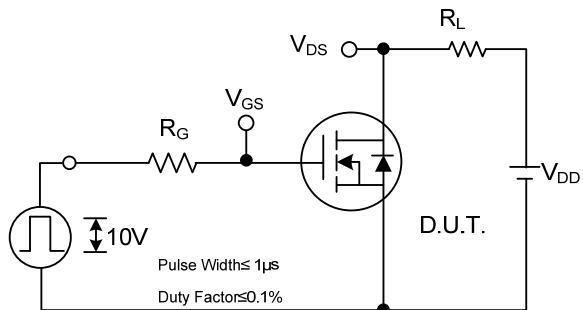


Peak Diode Recovery dv/dt Test Circuit

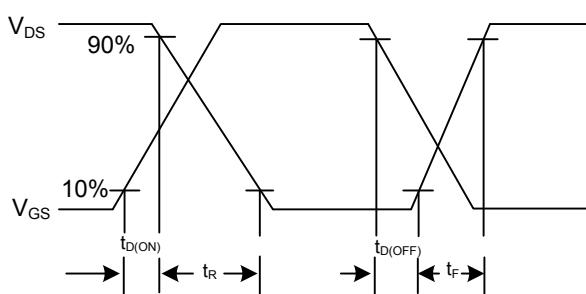


Peak Diode Recovery dv/dt Waveforms

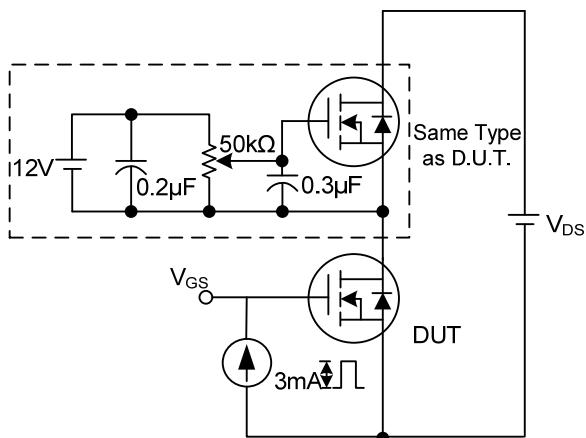
## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



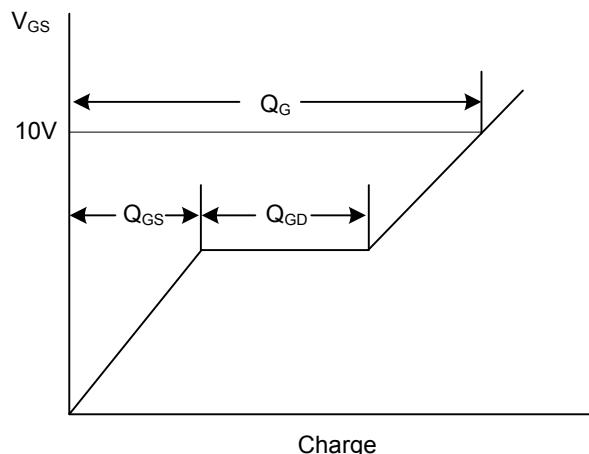
Switching Test Circuit



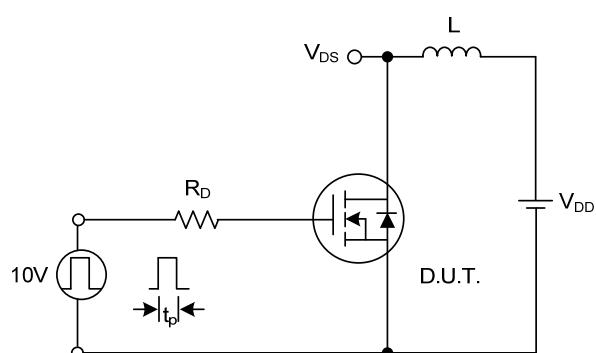
Switching Waveforms



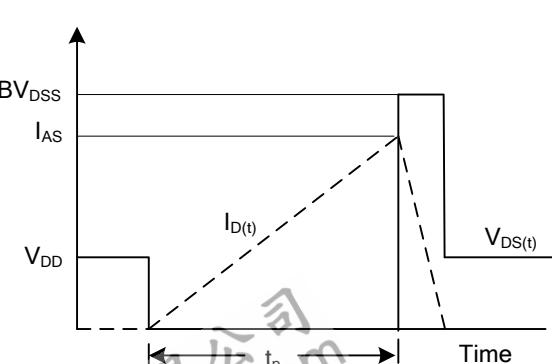
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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